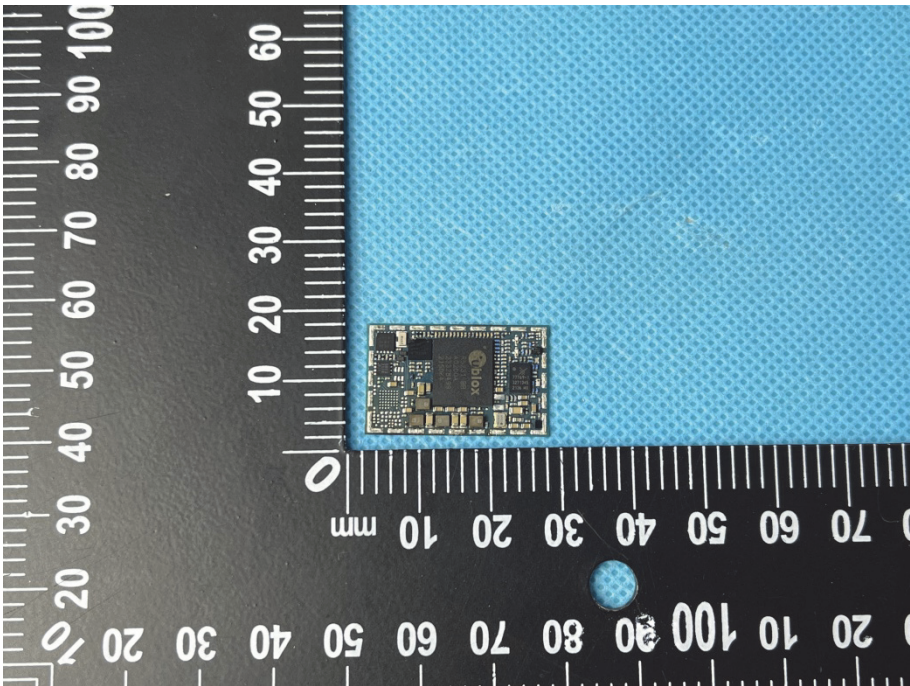
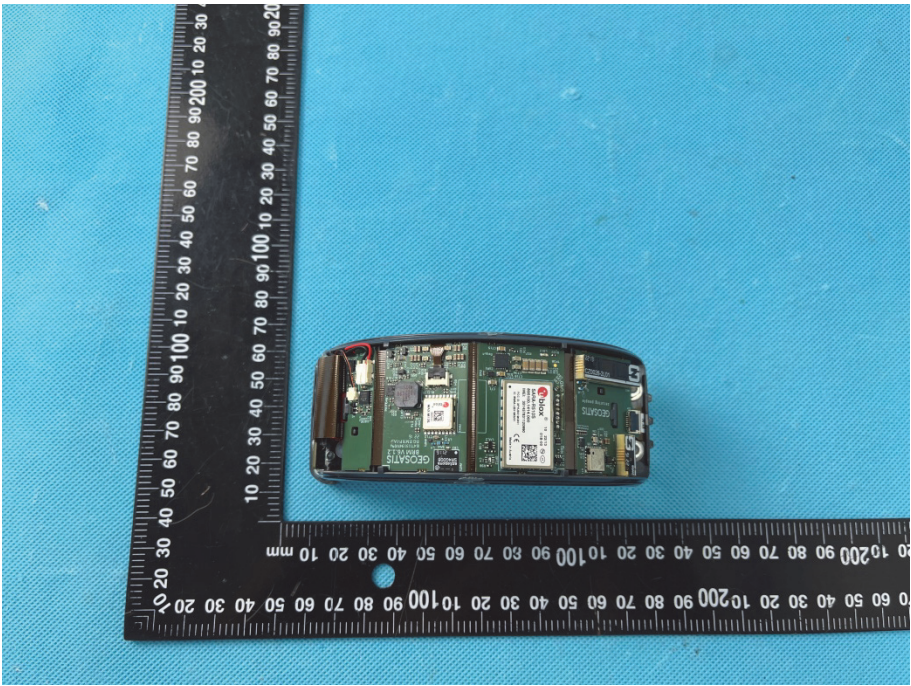
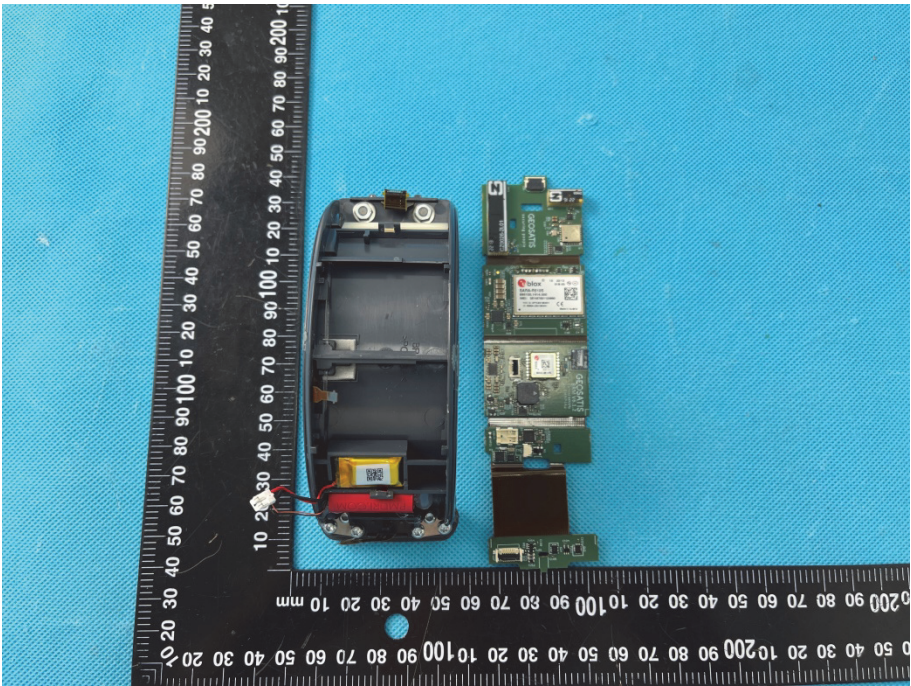
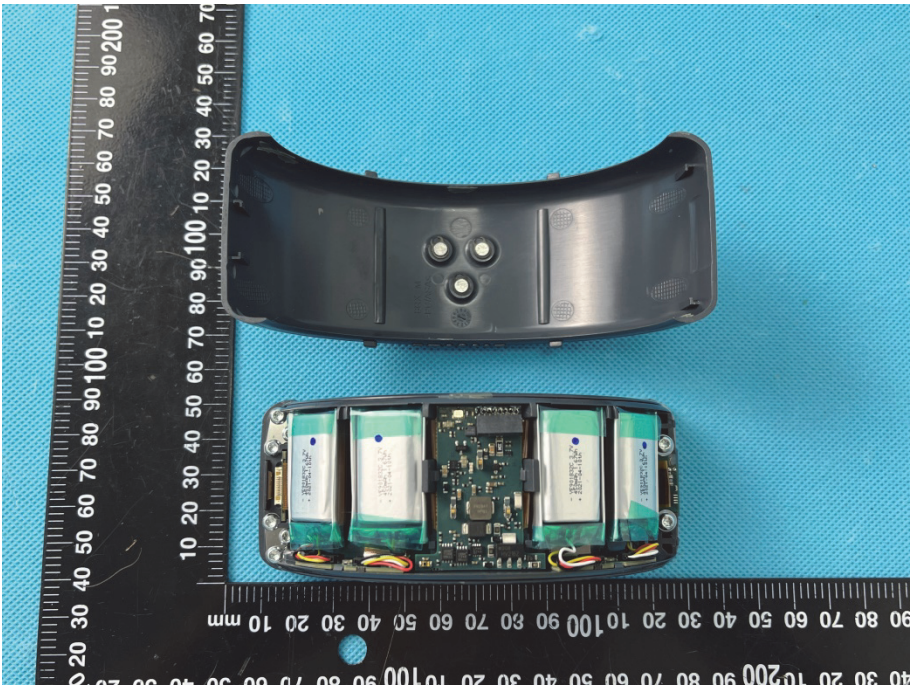
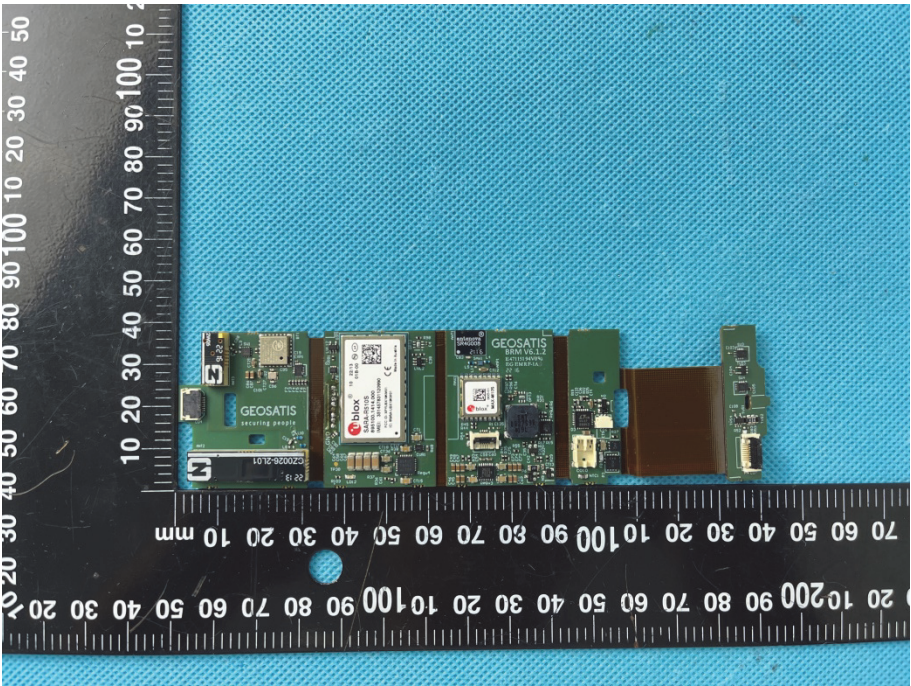
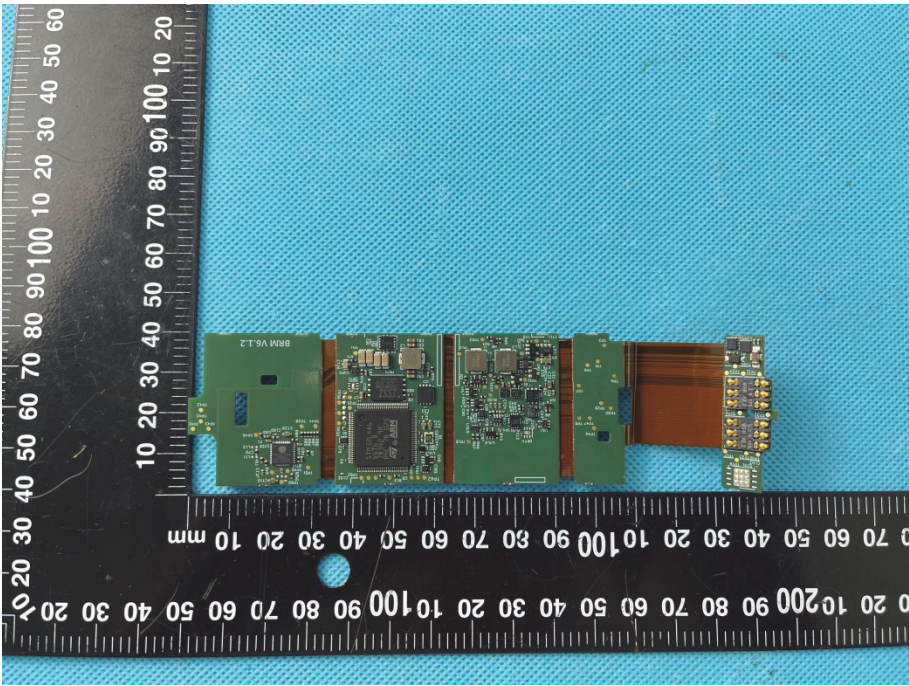
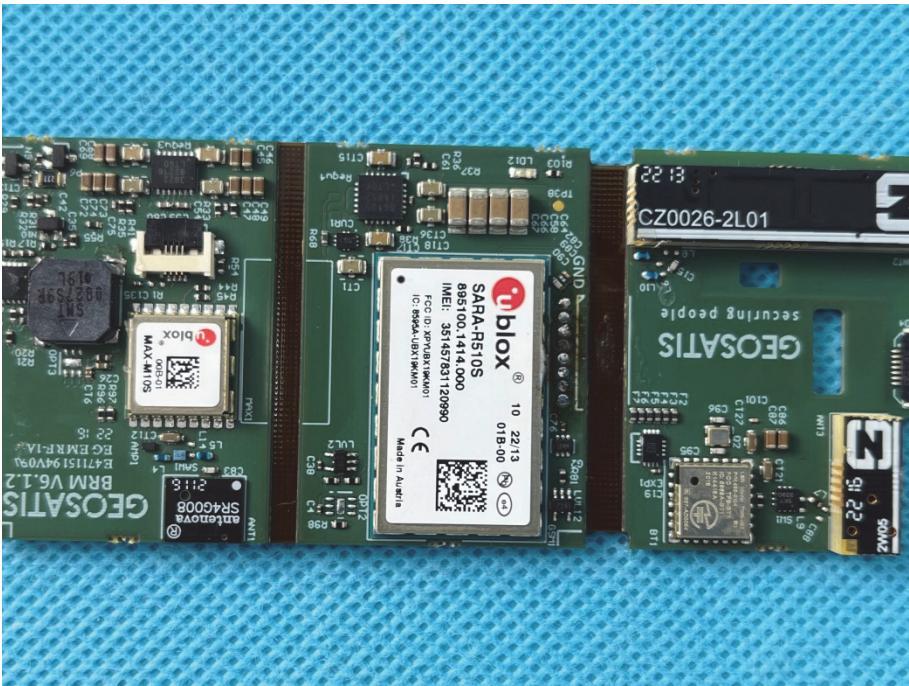


EXHIBIT 3 - EUT INTERNAL PHOTOGRAPHS

Solder Board-Component View	 A photograph showing a small, rectangular electronic component (likely a microcontroller or sensor) mounted on a blue solder mask. The component is positioned next to a black ruler with white markings, which shows measurements in millimeters (0 to 100 mm) and centimeters (0 to 10 cm). The component is approximately 10 mm long and 5 mm wide.
Host Housing and Board View 1	 A photograph showing a larger, rectangular electronic component (likely a microcontroller or sensor) mounted on a blue solder mask. The component is positioned next to a black ruler with white markings, which shows measurements in millimeters (0 to 100 mm) and centimeters (0 to 10 cm). The component is approximately 100 mm long and 20 mm wide.

Host Housing and Board View 2	 A photograph showing the internal components of a device, including the host housing and the main board, placed next to a ruler for scale. The components are laid out on a blue surface. The ruler shows measurements in millimeters and centimeters.
Host Housing and Board View 3	 A photograph showing the internal components of a device, including the host housing and the main board, placed next to a ruler for scale. The components are laid out on a blue surface. The ruler shows measurements in millimeters and centimeters.

Host Housing and Board View 4	 A photograph showing the back of a black plastic host housing and the internal circuit board. The housing is curved and has two circular ports. The circuit board is green and populated with various components, including three large green capacitors. A black ruler with white markings is placed vertically to the left of the components for scale.
Host Solder Board-Component View 1	 A photograph showing the solder side of the circuit board. It features several integrated circuits, including a large black chip labeled 'GEOSATIS' and a smaller chip labeled 'M300'. A black ruler with white markings is placed vertically to the left of the board for scale.

Host Solder Board-Component View 2	 A photograph showing a green printed circuit board (PCB) with various electronic components, including a large integrated circuit (IC) and several smaller components. The board is placed on a blue textured surface. A black ruler with white markings is positioned vertically to the left of the board, showing measurements in millimeters (0 to 100 mm) and centimeters (0 to 10 cm).
Host Solder Board-Component View 3	 A photograph showing a green printed circuit board (PCB) with various electronic components. The board is placed on a blue textured surface. A black ruler with white markings is positioned vertically to the left of the board, showing measurements in millimeters (0 to 100 mm) and centimeters (0 to 10 cm). The components include a large integrated circuit (IC) with a label that reads "u-blox SARA-R510S 895100.1414.000 IMEI: 351457631120990", a smaller IC labeled "MAX-4105", and a component labeled "GEOSATIS".